IEEE P802.11
Wireless LANs

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| TGbe 2020 November to January teleconference minutes |
| Date: 2020-11-05 |
| Author(s): |
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|  |  |  |  |  |

Abstract

This document contains the minutes for November 2020 to January 2021 TGbe teleconferences.

Revisions:

* Rev0: First revision of the document. Added reference to teleconference calls 2nd of November. Added minutes to teleconference call 4th of November.
* Rev1: Added references to MAC teleconference call 5th of November. Added minutes to teleconference call 9th of November.
* Rev2: Added minutes to teleconference call 11th of November. Some typological updates, thanks to Alfred Asterjadhi.
* Rev3: Added participation list for the call 11th of November. Added minutes for joint call 18th of November. Added references to PHY ad-hoc November 12 and 16 and MAC ad-hoc November 12.
* Rev4: Added references to the split PHY/MAC calls the 19th and 30th of November. Added minutes to the joint call the 2nd of December.
* Rev5: Added participation list for the call 2nd of December. Added references to meetings held 3rd and 7th of December. Added minutes for joint call the 9th of December.
* Rev6: Added references to meetings held 10th and 14th of December. Added minutes for joint call the 16th of December.

# Monday 02 November, 19:00 – 21:00 ET

Split PHY and MAC.

* PHY: <https://mentor.ieee.org/802.11/dcn/20/11-20-1767-06-00be-minutes-for-tgbe-phy-ad-hoc-cc-nov-2020-to-jan-2021.docx>
* MAC: <https://mentor.ieee.org/802.11/dcn/20/11-20-1765-10-00be-minutes-for-tgbe-mac-ad-hoc-teleconferences-in-nov-2020-and-jan-2021.docx>

# Wednesday 04 November, 9:00 – 11:00 ET

**Introduction**

1. The Chair, Alfred Asterjadhi (Qualcomm), calls the meeting to order at 9:00 ET. The Chair notifies that the agenda is in 1615r7.
2. IEEE 802 and 802.11 IPR policy and procedure. If anyone in this meeting is personally aware of the holder of any patent claims that are potentially essential to implementation of the proposed standard(s) under consideration by this group please speak up now. Nobody speaks/writes up.
3. The Chair goes through **Patent, Participation and policy related subclause.**
4. Attendance reminder.
* Participation slide: <https://mentor.ieee.org/802-ec/dcn/16/ec-16-0180-05-00EC-ieee-802-participation-slide.pptx>
* Please record your attendance during the conference call by using the IMAT system:
	+ 1) login to [imat](https://imat.ieee.org/attendance), 2) select “802.11 Telecons (<Month>)” entry, 3) select “C/LM/WG802.11 Attendance” entry, 4) click “TGbe <MAC/PHY/Joint> conference call that you are attending.
* If you are unable to record the attendance via [IMAT](https://imat.ieee.org/attendance) then please send an e-mail to Dennis Sundman (dennis.sundman@ericsson.com) and Alfred Asterjadhi (aasterja@qti.qualcomm.com)
* Please ensure that the following information is listed correctly when joining the call:
	+ "[voter status] First Name Last Name (Affiliation)"
1. Agenda approved with unanimous consent.
2. Announcements:
3. Technical Submissions**-Sounding**
	1. [**1436r5**](https://mentor.ieee.org/802.11/dcn/20/11-20-1436-05-00be-ndpa-and-mimo-control-field-design-for-eht.pptx)**, “NDPA and MIMO Control Field Design for EHT” – Sameer Vermani**

**Summary:** The authors provide explicit design proposals for how to extend NDPA and MIMO control fields for EHT.

**Discussion:**

C: It looks like 7 bits are enough for the BW indication, but you mention 9 bits.

A: Some people seem to prefer a bitmap rather than a table, and in that case 9 bits are required.

C: Regarding the MIMO Control Field, have you thought about the single vs multi-AP case for this field?

A: No. I would think the reserved bits should suffice.

C: From slide 6, what is the special information?

A: I have nothing particular in mind, but when everything is filled up, we are left with only 2 bytes.

C: On slide 7, you suggest to indicate multi-AP and single-AP sounding.

A: I don’t want to go into detailed designs. If certain information needs to be indicated, it should be possible to convey it here. You could use the special STA Info Version field.

**SP2:**

Do you agree the design of STA Info field as shown below

* Partial BW Info field (naming is TBD) can be 7-9 bits [the figure will be modified accordingly if the field size is different from 9 bits]
* Size of codebook size may increase, and the location of the Nc and Codebook Size fields are TBD



**Result:** Yes/No/Abstain/No-answer: 97/27/62/158.

**SP 3:**

Do you agree with the EHT MIMO Control Field Design shown below?



* Size of codebook information may increase
* Reserved bits (number and location) may change
* Sounding Dialogue Token and Feedback Segment related bits are TBD
* Partial BW Info field (naming is TBD) can be 7-9 bits [the figure will be modified accordingly if the field size is different from 9 bits]

**Result:** Yes/No/Abstain/No-answer: 113/6/70/156

* 1. [**1643r1**](https://mentor.ieee.org/802.11/dcn/20/11-20-1643-01-00be-implicit-sounding-performance.pptx)**, “Implicit Sounding Performance” – Oren Kedem**

**Summary:** The authors have performed MU-MIMO tests in lab with focus on channel aging and calibration error. Channel aging is not much of an issue in the static case, however in the far and near movement scenario the EVM shows a drop. Whey claim that when calibration error is equal or smaller than -30dB, implicit sounding has better performance than explicit sounding. Explicit and implicit sounding performance becomes similar when sounding interval increases. The authors believe it is not hard to obtain -30dB calibration error.

1. Motions (concentrated within the second 60 mins of the call). [841r33](https://mentor.ieee.org/802.11/dcn/20/11-20-0841-33-00be-tgbe-motions-list-for-teleconferences.pptx) Motions list for teleconferences
	1. **Move to approve TGbe minutes of teleconferences listed below:**
		* Teleconferences Sept-Nov: <https://mentor.ieee.org/802.11/dcn/20/11-20-1496-08-00be-sep-nov-tgbe-teleconference-minutes.docx>

**Move:** Michael Montemurro, **Second:** Bin Tian

**Discussion: No discussion.**

**Result: Approved with unanimous consent.**

* 1. **Motion 137**

Move to add to the 11be SFD, candidate specification text in [11-20/566r86](https://mentor.ieee.org/802.11/dcn/20/11-20-0566-86-00be-compendium-of-straw-polls-and-potential-changes-to-the-specification-framework-document.docx) that is identified with the following tags:

* + SP244, SP245, SP246, SP247, SP248, SP249, SP250, SP251, SP252, SP253,
	+ SP254, SP255, SP256, SP257, SP258, SP259, SP262, SP263,
	+ SP264, SP265, SP266, SP267, SP268, SP269, SP270, SP271, SP272, SP273,
	+ SP274, SP275, SP276, SP277, SP278, SP279, SP280, SP281, SP282, SP283,
	+ SP284, SP285, SP286, SP287, SP288, SP289, SP290, SP291, SP292, SP293,
	+ SP294, SP295.

**Move:** Stephen McCann, **Second:** Subir Das

**Discussion:** No discussion.

**Result:** Approved with unanimous consent.

Note: These are all candidate SFD texts highlighted in yellow that have NOT received a request for further discussion

* 1. **Motion 138**

Move to accept changes to the TGbe draft as specified in the following documents:

* + [1650r1](https://mentor.ieee.org/802.11/dcn/20/11-20-1650-00-00be-proposed-tbd-fix-for-mld-association-sa-query.docx)

**Move:** Po-Kai Huang, **Second:** Rojan Chitrakar

**Discussion:** No discussion.

**Result:** Approved with unanimous consent.

Note: These are all proposed draft texts (PDTs) that obtained ≥ 75% support during the straw poll phase and that have NOT received a request for further discussion

* 1. **Motion 139**

Move to add to the 11be SFD, candidate specification text in [11-20/566r63](https://mentor.ieee.org/802.11/dcn/20/11-20-0566-63-00be-compendium-of-straw-polls-and-potential-changes-to-the-specification-framework-document.docx) that is identified with the following tag:

* + SP175

**Move:** Ron Porat, **Second:** Bin Tian

**Discussion:** No discussion.

**Result:** Approved with unanimous consent.

*SP175: Do you agree to the proposed RU table as attached on slide 5 of 1138r4?*

*[20/1138r4 (Large M-RU Table, Ron Porat, Broadcom), SP#3, Y/N/A: 30/9/8]*

* 1. **Motion 140**

Move to change the paragraph below in 36.3.18.3 of TGbe D0.1 as follows:

* Transmit center frequency and the symbol clock frequency for all transmit antennas and frequency segments shall be derived from the same reference oscillator. The symbol clock frequency and transmit center frequency tolerance shall be ±20 ppm in the 5 GHz and 6 GHz bands and ±25 ppm in the 2.4 GHz band. EHT TB PPDU format is subject to additional requirements as defined in 36.3.14 (Non-HT duplicate transmission)

**Move:** Wook Bong Lee, **Second:** Ross Jian Yu

**Discussion:** No discussion.

**Result:** Approved with unanimous consent.

*SP: Do you agree to change from +-2 ppm to +-25 ppm for 2.4 GHz band transmit center frequency tolerance? Note that it is a typo in section 36.3.18.3. Please refer 11-20/1252r2.*

*(SP result: Approved with unanimous consent)*

* 1. **Motion 141**

Move to add to the 11be SFD, the following text:

* + The allowed values of maximum NLTF receive capability for single-user transmission are 4, 8, and 16.
		- Note: The value of maximum NLTF=16 is available in R2
	+ The allowed values of maximum NLTF receive capability for multiple-user transmission are 4, 8, and 16.
		- Note 1: This capability is for both OFDMA and non-OFDMA MU-MIMO transmission.
		- Note 2: The value of maximum NLTF=16 is available in R2

**Move:** Rui Cao, **Second:** Junghoon Suh

**Discussion:** No discussion.

**Result:** Approved with unanimous consent.

Note 1: These are all candidate SFD texts highlighted in yellow that have received a request for further discussion

Note 2: SP results are SP260: 34Y,2N,17A and SP261: 38Y, 2N, 15A: see next slide for SP content

1. **Amending agenda. To continue the sounding SPs is 1436r5. There is no objection to amend the agenda. Amended agenda approved.**
2. [**1436r5**](https://mentor.ieee.org/802.11/dcn/20/11-20-1436-05-00be-ndpa-and-mimo-control-field-design-for-eht.pptx)**, “NDPA and MIMO Control Field Design for EHT” – Sameer Vermani**

**SP4**

Do you agree that the U-SIG in NDP will carry the puncturing information for the entire PPDU BW?

* + Same 5 bit field as other non-OFDMA PPDUs

**Discussion:** No discussion.

**Result:** Yes/No/Abstain/No-answer: 107/2/53/179

**SP5**

Do you agree with the following two rules

* + - NDPA shall not request feedback on a 242RU that is signaled as punctured in the U-SIG of the NDP that follows it
		- MIMO Control Field’s Partial BW Info field (naming TBD) will be the same as the one in NDPA

**Discussion:** No discussion.

**Result:** Yes/No/Abstain/No-answer: 121/2/45/174

1. **AoB: None.**
2. **Recess at 10:57.**

# Thursday 05 November, 9:00 – 11:00 ET

Only MAC:

* MAC: <https://mentor.ieee.org/802.11/dcn/20/11-20-1765-10-00be-minutes-for-tgbe-mac-ad-hoc-teleconferences-in-nov-2020-and-jan-2021.docx>

# Monday 9 November, 9:00 – 11:00 ET

**Introduction**

1. The Chair, Alfred Asterjadhi (Qualcomm), calls the meeting to order at 9:01 ET. The Chair notifies that the agenda is in 1615r9.
2. IEEE 802 and 802.11 IPR policy and procedure. If anyone in this meeting is personally aware of the holder of any patent claims that are potentially essential to implementation of the proposed standard(s) under consideration by this group please speak up now. Nobody speaks/writes up.
3. The Chair goes through **Patent, Participation and policy related subclause,** which is located at the bottom of the agenda document.
4. Attendance reminder.
* Participation slide: <https://mentor.ieee.org/802-ec/dcn/16/ec-16-0180-05-00EC-ieee-802-participation-slide.pptx>
* Please record your attendance during the conference call by using the IMAT system:
	+ 1) login to [imat](https://imat.ieee.org/attendance), 2) select “802.11 Telecons (<Month>)” entry, 3) select “C/LM/WG802.11 Attendance” entry, 4) click “TGbe <MAC/PHY/Joint> conference call that you are attending.
* If you are unable to record the attendance via [IMAT](https://imat.ieee.org/attendance) then please send an e-mail to Dennis Sundman (dennis.sundman@ericsson.com) and Alfred Asterjadhi (aasterja@qti.qualcomm.com)
* Please ensure that the following information is listed correctly when joining the call:
	+ "[voter status] First Name Last Name (Affiliation)"
1. The Chair goes through the agenda. Agenda approved with unanimous consent.
2. Announcements:
3. Technical Submissions**-Sounding**
	1. [**1643r1**](https://mentor.ieee.org/802.11/dcn/20/11-20-1643-01-00be-implicit-sounding-performance.pptx)**, “Implicit Sounding Performance” – Oren Kedem [Q&A+SP]**

Oren recaps the presentation.

**Discussion:**

C: I think your results look very optimistic.

A: We have chosen values which we believe are realistic or even pessimistic.

C: In the simulations, did you assume near or far movement?

A: For the simulations we only put results here for near movement.

C: Would be very nice to see real world evaluations before we can commit on it.

A: We would still like to run the SP since

SP:

Do you support to add implicit sounding in R2 as an optional mode in TGbe?

Result: Yes/No/Abstain/No-answer: 79/47/40/80.

1. Technical Submissions**-Trigger** (one or more submissions could move after motions)
	1. [**1669r2**](https://mentor.ieee.org/802.11/dcn/20/11-20-1669-02-00be-spatial-stream-allocation-in-trigger-frames.pptx)**, “Spatial-stream-allocation-in-trigger-frames” – Mengshi Hu**

**Summary:** Due to increased number of antennas in .11be, more spatial streams are possible compared to .11ax. The authors show 3 options on how to signal this.

 **Discussion:**

 Yes. Discussion regarding pros and cons for the different options.

**SP1:**

Do you agree that a 4-bit Number of Spatial Streams is used fo SS Allocation of a non-MU-MIMO user in the User Info field of a trigger frame?

Discussion:

Short discussion regarding maybe running strawpolls in different order.

**Result:** Yes/No/Abstain/No-answer: 49/51/58/98.

**SP2:**

Do you agree that a 4-bit Starting Spatial Stream and a 2-bit Number Of Spatial Streams are used for SS Allocation of an MU-MIMO user in the User Info field of a trigger frame?

**Discussion:**

C: Can you defer this straw poll?

A: Yes.

*The Chair asks if it is OK to amend the agenda and run motions now. No objections, agenda amended.*

1. [841r36](https://mentor.ieee.org/802.11/dcn/20/11-20-0841-36-00be-tgbe-motions-list-for-teleconferences.pptx) Motions list for teleconferences
	1. **Motion 142**

**Move to add to the 11be SFD, candidate specification text in** [**11-20/566r90**](https://mentor.ieee.org/802.11/dcn/20/11-20-0566-90-00be-compendium-of-straw-polls-and-potential-changes-to-the-specification-framework-document.docx) **that is identified with the following tags:**

SP296, SP297, SP298, SP299, SP300, SP301, SP302, SP303, SP304, SP305,

SP306, SP307, SP308, SP309, SP310.

**Move: Bin Tian Second: Laurent Cariou**

**Discussion: No discussion.**

**Result: Approved with unanimous consent.**

**Note: These are all candidate SFD texts highlighted in yellow that have NOT received a request for further discussion**

* 1. **Motion 143**

**Move to accept changes to the TGbe draft as specified in the following documents:**

* + - [1726r0](https://mentor.ieee.org/802.11/dcn/20/11-20-1726-00-00be-pdt-phy-ppdu-formats-for-clause-36-1-4.docx)

**Move: Jinsoo Choi Second: Edward Au**

**Discussion: No discussion.**

**Result: Approved with unanimous consent.**

**Note: These are all proposed draft texts (PDTs) that obtained ≥ 75% support during the straw poll phase and that have NOT received a request for further discussion**

1. Technical Submissions**-Trigger** (one or more submissions could move after motions)

1. [**1685r0**](https://mentor.ieee.org/802.11/dcn/20/11-20-1685-00-00be-ul-length-indication-in-trigger-frame.pptx)**, “UL length indication in trigger frame” – Ross Jian Yu**

**Summary:** The authors propose how an EHT AP shall set the length field in L\_SIG for EHT TB PPDU.

**Discussion:**

C: It is always tricky with these ceils, floors +-1 etc. Have you double-checked that the +2 in SP2 keeps the duration correct?

A: Yes.

C: The point here is that EHT TB PPDU always use m = 2?

A: Yes.

C: The L\_SIG length for both HE and TB PPDU will have the same value, right?

A: Yes.

Some discussion regarding autodetection in HE and EHT.

**SP1**

Do you agree that an EHT AP shall set the UL Length subfield of a trigger frame to the value given by the following equation with m = 2 if the trigger frame is to solicit EHT TB PPDU?

* + 1. This is for R1



**Discussion:**

C: I believe we are straw polling the future.

A: This is needed now already now.

C: Why not set m = 0?

A: By setting it to m = 2, the AP does not need to make any change compared to .11ax.

**Result:** Yes/No/Abstain/No-answer: 52/23/88/95

*The Chair asks if there is any objection to amend the agenda by adding 1429r2 to the agenda. No objection. Amended agenda approved.*

1. Deferred SPs on Trigger
	1. [**1429r2**](https://mentor.ieee.org/802.11/dcn/20/11-20-1429-02-00be-enhanced-trigger-frame-for-eht-support.pptx)**, “Enhanced Trigger Frame for EHT Support” – Steve Shellhammer**

**SP7:**

* Do you agree to use four bits of the Trigger Frame User Info Field Spatial Stream Allocation subfield to indicate the starting spatial stream, and two bits to indicate the number of per-user spatial streams?
	+ Note: This supports up to a total of 16 spatial streams with up to four spatial streams per-user

**Discussion:**

C: Do you have a unified SU/MU case?

A: Yes, we would use this 4+2 bits.

C: How do you indicate that some bits are used for SU or MU MIMO.

A: We don’t distinguish it.

C: We still prefer to have SU/MU MIMO indication. If you can defer the SP I would appreciate it.

A: Ok, I defer it.

**SP9:**

* Do you agree to include a Lower/Upper 160 MHz Segment bit in the Trigger Frame User Info Field?
	+ Note: Combining this bit with the 8-bit RU Allocation subfield provides an effective 9-bit field, which is sufficient for supporting all RUs and MRUs. (See Backup)

**Discussion:**

C: I am not sure this is good notation compared to MAC, where we typically have primary/secondary rather than upper/lower etc.

Result: Yes/No/Abstain/No-answer: 56/33/58/109.

1. AoB.
	1. C: Do we need the next call?
	A: Mainly presentations on the sounding.
2. Adjourn at 11:00 ET, final call of the plenary.

# Wednesday 11 November 10:00 – 12:00 ET

**Introduction**

1. The Chair, Alfred Asterjadhi (Qualcomm), calls the meeting to order at 10:01 ET. The Chair notifies that the agenda is in 1615r11.
2. IEEE 802 and 802.11 IPR policy and procedure. If anyone in this meeting is personally aware of the holder of any patent claims that are potentially essential to implementation of the proposed standard(s) under consideration by this group please speak up now. Nobody speaks/writes up.
3. The Chair goes through **Patent, Participation and policy related subclause,** which is located at the bottom of the agenda document.
4. Attendance reminder.
* Participation slide: <https://mentor.ieee.org/802-ec/dcn/16/ec-16-0180-05-00EC-ieee-802-participation-slide.pptx>
* Please record your attendance during the conference call by using the IMAT system:
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* If you are unable to record the attendance via [IMAT](https://imat.ieee.org/attendance) then please send an e-mail to Dennis Sundman (dennis.sundman@ericsson.com) and Alfred Asterjadhi (aasterja@qti.qualcomm.com)
* Please ensure that the following information is listed correctly when joining the call:
	+ "[voter status] First Name Last Name (Affiliation)"
* Attendence as recorded by IMAT:
* AbidRabbu, Shaima' Istanbul Medipol University; Vestel
* Aboulmagd, Osama Huawei Technologies Co.,  Ltd
* Abushattal, Abdelrahman Istanbul Medipol university ;Vestel
* An, Song-Haur INDEPENDENT
* Ansley, Carol IEEE member / Self Employed
* Anwyl, Gary MediaTek Inc.
* Asterjadhi, Alfred Qualcomm Incorporated
* B, Hari Ram NXP Semiconductors
* Baek, SunHee LG ELECTRONICS
* Bankov, Dmitry IITP RAS
* baron, stephane Canon Research Centre France
* ben yahia, olfa Olfa ben yahia  Vestel
* Bluschke, Andreas Signify
* Bredewoud, Albert Broadcom Corporation
* Cao, Rui NXP Semiconductors
* Carney, William Sony Corporation
* CHAN, YEE Facebook
* chen, jindou Huawei Technologies Co. Ltd
* Chen, Na MaxLinear Corp
* Cheng, Paul MediaTek Inc.
* CHERIAN, GEORGE Qualcomm Incorporated
* Chitrakar, Rojan Panasonic Asia Pacific Pte Ltd.
* Choi, Jinsoo LG ELECTRONICS
* Chu, Liwen NXP Semiconductors
* CHUN, JINYOUNG LG ELECTRONICS
* Coffey, John Realtek Semiconductor Corp.
* Das, Subir Perspecta Labs Inc.
* de Vegt, Rolf Qualcomm Incorporated
* Dong, Xiandong Xiaomi Inc.
* Duan, Ruchen SAMSUNG
* Fang, Yonggang Self
* feng, Shuling MediaTek Inc.
* Fischer, Matthew Broadcom Corporation
* Ganwani, Vijay NXP Semiconductors
* Gao, Zhigang Cisco Systems, Inc.
* Ghaderipoor, Alireza MediaTek Inc.
* Gong, Bo Huawei Technologies Co. Ltd
* Guo, Yuchen Huawei Technologies Co., Ltd
* Han, Zhiqiang ZTE Corporation
* Handte, Thomas Sony Corporation
* Hart, Brian Cisco Systems, Inc.
* Hervieu, Lili Cable Television Laboratories Inc. (CableLabs)
* Ho, Duncan Qualcomm Incorporated
* Hong, Hanseul WILUS Inc.
* Hsieh, Hung-Tao MediaTek Inc.
* Hsu, Chien-Fang MediaTek Inc.
* Hu, Chunyu Facebook
* Huang, Guogang  Huawei
* Huang, Lei Guangdong OPPO Mobile Telecommunications Corp.,Ltd
* Jamalabdollahi, Mohsen Cisco Systems, Inc.
* Jang, Insun LG ELECTRONICS
* Jeon, Eunsung SAMSUNG ELECTRONICS
* Jiang, Jinjing Apple, Inc.
* Kakani, Naveen Qualcomm Incorporated
* Kandala, Srinivas SAMSUNG
* Kedem, Oren Huawei Technologies Co. Ltd
* Kim, Jeongki LG ELECTRONICS
* Kim, Myeong-Jin SAMSUNG
* kim, namyeong LG ELECTRONICS
* Kim, Sanghyun WILUS Inc
* Kim, Youhan Qualcomm Incorporated
* Klein, Arik Huawei Technologies Co. Ltd
* Klimakov, Andrey Huawei Technologies Co., Ltd
* Klimker, Amos Maxlinear
* Ko, Geonjung WILUS Inc.
* Kondo, Yoshihisa Advanced Telecommunications Research Institute International (ATR)
* Lalam, Massinissa SAGEMCOM BROADBAND SAS
* Lansford, James Qualcomm Incorporated
* Lee, Wookbong SAMSUNG
* Levitsky, Ilya IITP RAS
* Levy, Joseph InterDigital, Inc.
* Li, Yiqing Huawei Technologies Co. Ltd
* Li, Yunbo Huawei Technologies Co., Ltd
* Lim, Dong Guk LG ELECTRONICS
* LIU, CHENCHEN Huawei Technologies Co., Ltd
* Liu, Der-Zheng Realtek Semiconductor Corp.
* Liu, Jianfei HUAWEI
* Liu, Jianhan MediaTek Inc.
* Liu, Yong Apple, Inc.
* Lu, kaiying MediaTek Inc.
* Lu, Liuming ZTE Corporation
* Luo, Chaoming Beijing OPPO telecommunications corp., ltd.
* Ma, Li MediaTek Inc.
* Ma, Mengyao HUAWEI
* McCann, Stephen Huawei Technologies Co.,  Ltd
* Memisoglu, Ebubekir Istanbul Medipol University; Vestel
* Monajemi, Pooya Cisco Systems, Inc.
* Montemurro, Michael Huawei Technologies Co. Ltd
* Montreuil, Leo Broadcom Corporation
* NANDAGOPALAN, SAI SHANKAR Cypress Semiconductor Corporation
* Nezou, Patrice Canon Research Centre France
* Ozpoyraz, Burak Vestel
* Park, Eunsung LG ELECTRONICS
* Park, Minyoung Intel Corporation
* Patil, Abhishek Qualcomm Incorporated
* Patwardhan, Gaurav Hewlett Packard Enterprise
* Petrick, Albert InterDigital, Inc.
* Puducheri, Srinath Broadcom Corporation
* Pushkarna, Rajat Panasonic Asia Pacific Pte Ltd.
* Rai, Kapil Qualcomm Incorporated
* Raissinia, Alireza Qualcomm Incorporated
* Redlich, Oded HUAWEI
* Rege, Kiran Perspecta Labs
* Reshef, Ehud Intel Corporation
* Roder, Patricia IEEE STAFF
* Schelstraete, Sigurd Quantenna Communications, Inc.
* Sedin, Jonas Ericsson AB
* Sethi, Ankit NXP Semiconductors
* Shellhammer, Stephen Qualcomm Incorporated
* Shilo, Shimi HUAWEI
* Solaija, Muhammad Sohaib Istanbul Medipol University; Vestel
* SUH, JUNG HOON Huawei Technologies Co. Ltd
* Sun, Bo ZTE Corporation
* Sun, Li-Hsiang InterDigital, Inc.
* Sundman, Dennis Ericsson AB
* Tadahal, Shivkumar Broadcom Corporation
* Tanaka, Yusuke Sony Corporation
* Tian, Bin Qualcomm Incorporated
* Torab Jahromi, Payam Facebook
* Urabe, Yoshio Panasonic Corporation
* Ustunbas, Seda Vestel
* VIGER, Pascal Canon Research Centre France
* Wang, Chao Chun MediaTek Inc.
* Wang, Lei Futurewei Technologies
* Wang, Xiaofei InterDigital, Inc.
* Wilhelmsson, Leif Ericsson AB
* Xin, Yan Huawei Technologies Co., Ltd
* Yang, Jay Nokia
* YANG, RUI InterDigital, Inc.
* Yang, Steve TS MediaTek Inc.
* Yano, Kazuto Advanced Telecommunications Research Institute International (ATR)
* Yee, James MediaTek Inc.
* yi, yongjiang Futurewei Technologies
* Yu, Jian Huawei Technologies Co., Ltd
* Yukawa, Mitsuyoshi Canon, Inc.
* Zein, Nader NEC Laboratories Europe
* Zhang, Yan NXP Semiconductors
* Zhou, Yifan Huawei Technologies Co., Ltd
* Zuo, Xin Tencent
1. Announcements:
	* We are planning to deliver draft 0.2 in December. To make it into 0.2 it needs to be added to motion list before November 19.

The Chair asks if there is any suggestions for modifications to the **agenda**. Nobody speaks up. The agenda is approved with unanimous consent.

1. Technical Submissions**-Sounding**
	1. [**1747r0**](https://mentor.ieee.org/802.11/dcn/20/11-20-1747-00-00be-eht-ndpa-partial-bw-info-design.pptx)**, “EHT NDPA Partial BW Info Design” – Rui Cao**

Summary: The authors propose a design for signalling the partial BW info. They propose a bitmap, which requires 9 bits.

Discussion:

C: I think NDPA must support feedback of 20 MHz for 320 MHz.

A: As I understand it, that will not be needed.

C: I prefer the table based method since we can signal in 20 MHz resolution even for 320 MHz.

*Some more discussion on the restriction of only allowing 40 MHz resolution for 320 MHz.*

* 1. [**1469r0**](https://mentor.ieee.org/802.11/dcn/20/11-20-1469-00-00be-eht-sounding-discussion.pptx)**, “EHT sounding discussion” – Liwen Chu**

Summary: The authors present ideas and suggestions for simplifications of the 802.11ax sounding, to better support the larger number of spatial streams and wider bandwidth.

Discussion:

C: The beamforming report, will it exceed the maximal length of MPDU?

A: It can happen.

C: I would like to check with our implementation team, it would be good if you can wait with the straw poll.

* 1. [**1814r0**](https://mentor.ieee.org/802.11/dcn/20/11-20-1814-00-00be-partial-bw-info-field-design-in-ndpa.pptx)**, “Partial BW Info Field Design in NDPA” – Eunsung Park**

Summary: The authors propose 3 different options for the Partial BW Info Field design. The first 2 options are based on bitmaps, and the 3rd option based on table.

Discussion:

C: So, with memory in option 3 you refer to the new table?

A: Yes.

* 1. [**1015r5**](https://mentor.ieee.org/802.11/dcn/20/11-20-1015-05-00be-eht-ndpa-frame-design-discussion.pptx)**, “EHT NDPA Frame Design Discussion” – Ross Jian Yu**

Summary: This is an updated presentation.

Discussion:

Some discussion whether bitmap or table is a better design principle.

C: You are actually not really proposing a clear table design since you use 8 bits plus some additional information.

A: True.

1. Deferred SPs **on Trigger**
	* *Pending Requests*
2. AoB: No other business.
3. Adjourn at 11:41 ET.

# Wednesday 12 November 10:00 – 12:00 ET

Split PHY and MAC.

* PHY: <https://mentor.ieee.org/802.11/dcn/20/11-20-1767-06-00be-minutes-for-tgbe-phy-ad-hoc-cc-nov-2020-to-jan-2021.docx>
* MAC: <https://mentor.ieee.org/802.11/dcn/20/11-20-1765-10-00be-minutes-for-tgbe-mac-ad-hoc-teleconferences-in-nov-2020-and-jan-2021.docx>

# Wednesday 16 November 10:00 – 12:00 ET

Split PHY and MAC.

* PHY: <https://mentor.ieee.org/802.11/dcn/20/11-20-1767-06-00be-minutes-for-tgbe-phy-ad-hoc-cc-nov-2020-to-jan-2021.docx>
* MAC: <https://mentor.ieee.org/802.11/dcn/20/11-20-1765-10-00be-minutes-for-tgbe-mac-ad-hoc-teleconferences-in-nov-2020-and-jan-2021.docx>

# Wednesday 18 November 10:00 – 12:00 ET

**Introduction**

1. The Chair, Alfred Asterjadhi (Qualcomm), calls the meeting to order at 10:02 ET. The Chair notifies that the agenda is in [1615r13](https://mentor.ieee.org/802.11/dcn/20/11-20-1615-13-00be-nov-jan-tgbe-teleconference-agendas.docx).
2. IEEE 802 and 802.11 IPR policy and procedure. If anyone in this meeting is personally aware of the holder of any patent claims that are potentially essential to implementation of the proposed standard(s) under consideration by this group please speak up now. Nobody speaks/writes up.
3. The Chair goes through **Patent, Participation and policy related subclause,** which is located at the bottom of the agenda document.
4. Attendance reminder.
* Participation slide: <https://mentor.ieee.org/802-ec/dcn/16/ec-16-0180-05-00EC-ieee-802-participation-slide.pptx>
* Please record your attendance during the conference call by using the IMAT system:
	+ 1) login to [imat](https://imat.ieee.org/attendance), 2) select “802.11 Telecons (<Month>)” entry, 3) select “C/LM/WG802.11 Attendance” entry, 4) click “TGbe <MAC/PHY/Joint> conference call that you are attending.
* If you are unable to record the attendance via [IMAT](https://imat.ieee.org/attendance) then please send an e-mail to Dennis Sundman (dennis.sundman@ericsson.com) and Alfred Asterjadhi (aasterja@qti.qualcomm.com)
* Please ensure that the following information is listed correctly when joining the call:
	+ "[voter status] First Name Last Name (Affiliation)"
* Attendence as recorded by IMAT:
* Aboulmagd, Osama Huawei Technologies Co.,  Ltd
* Adhikari, Shubhodeep Broadcom Corporation
* Aio, Kosuke Sony Corporation
* Akhmetov, Dmitry Intel Corporation
* An, Song-Haur INDEPENDENT
* Anwyl, Gary MediaTek Inc.
* Asterjadhi, Alfred Qualcomm Incorporated
* B, Hari Ram NXP Semiconductors
* Baek, SunHee LG ELECTRONICS
* Bankov, Dmitry IITP RAS
* baron, stephane Canon Research Centre France
* Bredewoud, Albert Broadcom Corporation
* Cao, Rui NXP Semiconductors
* Carney, William Sony Corporation
* CHAN, YEE Facebook
* Chen, Na MaxLinear Corp
* Cheng, Paul MediaTek Inc.
* Chitrakar, Rojan Panasonic Asia Pacific Pte Ltd.
* Choo, Seungho Senscomm Semiconductor Co., Ltd.
* Chu, Liwen NXP Semiconductors
* CHUN, JINYOUNG LG ELECTRONICS
* Coffey, John Realtek Semiconductor Corp.
* Das, Dibakar Intel Corporation
* Das, Subir Perspecta Labs Inc.
* Davies, Robert Signify
* de Vegt, Rolf Qualcomm Incorporated
* Dong, Xiandong Xiaomi Inc.
* Duan, Ruchen SAMSUNG
* Fang, Yonggang Self
* feng, Shuling MediaTek Inc.
* Fischer, Matthew Broadcom Corporation
* Gao, Zhigang Cisco Systems, Inc.
* Ghaderipoor, Alireza MediaTek Inc.
* Gong, Bo Huawei Technologies Co. Ltd
* Guo, Yuchen Huawei Technologies Co., Ltd
* Han, Jonghun SAMSUNG
* Han, Zhiqiang ZTE Corporation
* Handte, Thomas Sony Corporation
* Hart, Brian Cisco Systems, Inc.
* Hervieu, Lili Cable Television Laboratories Inc. (CableLabs)
* Ho, Duncan Qualcomm Incorporated
* Hong, Hanseul WILUS Inc.
* Hsieh, Hung-Tao MediaTek Inc.
* Hu, Chunyu Facebook
* Huang, Lei Guangdong OPPO Mobile Telecommunications Corp.,Ltd
* Huang, Po-Kai Intel Corporation
* Jamalabdollahi, Mohsen Cisco Systems, Inc.
* Jeon, Eunsung SAMSUNG ELECTRONICS
* Jiang, Jinjing Apple, Inc.
* Kakani, Naveen Qualcomm Incorporated
* Kandala, Srinivas SAMSUNG
* Kedem, Oren Huawei Technologies Co. Ltd
* Kim, Myeong-Jin SAMSUNG
* Kim, Youhan Qualcomm Incorporated
* Kishida, Akira Nippon Telegraph and Telephone Corporation (NTT)
* Klein, Arik Huawei Technologies Co. Ltd
* Kneckt, Jarkko Apple, Inc.
* Kondo, Yoshihisa Advanced Telecommunications Research Institute International (ATR)
* Kwon, Young Hoon NXP Semiconductors
* Lansford, James Qualcomm Incorporated
* Lee, Wookbong SAMSUNG
* Levitsky, Ilya IITP RAS
* Levy, Joseph InterDigital, Inc.
* Li, Yiqing Huawei Technologies Co. Ltd
* Li, Yunbo Huawei Technologies Co., Ltd
* Lim, Dong Guk LG ELECTRONICS
* Liu, Der-Zheng Realtek Semiconductor Corp.
* Liu, Jianfei HUAWEI
* Lorgeoux, Mikael Canon Research Centre France
* Lou, Hanqing InterDigital, Inc.
* Lu, kaiying MediaTek Inc.
* Lu, Liuming ZTE Corporation
* Ma, Li MediaTek Inc.
* Max, Sebastian Ericsson AB
* McCann, Stephen Huawei Technologies Co.,  Ltd
* Memisoglu, Ebubekir Istanbul Medipol University; Vestel
* Mirfakhraei, Khashayar Cisco Systems, Inc.
* Montemurro, Michael Huawei Technologies Co. Ltd
* NANDAGOPALAN, SAI SHANKAR Cypress Semiconductor Corporation
* Nezou, Patrice Canon Research Centre France
* noh, yujin Newracom Inc.
* Ouchi, Masatomo Canon
* Ozbakis, Basak VESTEL
* OZDEN ZENGIN, OZLEM VESTEL
* Pare, Thomas MediaTek Inc.
* Park, Eunsung LG ELECTRONICS
* Park, Minyoung Intel Corporation
* Patil, Abhishek Qualcomm Incorporated
* Patwardhan, Gaurav Hewlett Packard Enterprise
* porat, ron Broadcom Corporation
* Rai, Kapil Qualcomm Incorporated
* Redlich, Oded HUAWEI
* Rosdahl, Jon Qualcomm Technologies, Inc.
* Salman, Hanadi Istanbul Medipol University; VESTEL
* Schelstraete, Sigurd Quantenna Communications, Inc.
* Sedin, Jonas Ericsson AB
* Sethi, Ankit NXP Semiconductors
* Sevin, Julien Canon Research Centre France
* Shellhammer, Stephen Qualcomm Incorporated
* Shilo, Shimi HUAWEI
* Solaija, Muhammad Sohaib Istanbul Medipol University; Vestel
* SUH, JUNG HOON Huawei Technologies Co. Ltd
* Sun, Bo ZTE Corporation
* Sun, Yanjun Qualcomm Incorporated
* Sundman, Dennis Ericsson AB
* THOUMY, Francois Canon Research Centre France
* Tian, Bin Qualcomm Incorporated
* Tsodik, Genadiy Huawei Technologies Co. Ltd
* Urabe, Yoshio Panasonic Corporation
* Van Zelst, Allert Qualcomm Incorporated
* Varshney, Prabodh Nokia
* Verenzuela, Daniel Sony Corporation
* Vermani, Sameer Qualcomm Incorporated
* VIGER, Pascal Canon Research Centre France
* Wang, Chao Chun MediaTek Inc.
* Wang, Huizhao Quantenna Communications, Inc.
* Wang, Lei Futurewei Technologies
* Wang, Qi Apple, Inc.
* Wentink, Menzo Qualcomm
* Wilhelmsson, Leif Ericsson AB
* Wu, Tianyu Apple, Inc.
* Wullert, John Perspecta Labs
* Xin, Yan Huawei Technologies Co., Ltd
* Yan, Aiguo Oppo
* Yang, Jay Nokia
* Yang, Steve TS MediaTek Inc.
* Yano, Kazuto Advanced Telecommunications Research Institute International (ATR)
* Yee, James MediaTek Inc.
* yi, yongjiang Futurewei Technologies
* Young, Christopher Broadcom Corporation
* Yu, Jian Huawei Technologies Co., Ltd
* ZEGRAR, Salah Eddine Istanbul Medipol University; Vestel
* Zein, Nader NEC Laboratories Europe
* Zhang, Yan NXP Semiconductors
* Zhou, Yifan Huawei Technologies Co., Ltd
* Additional attendance recorded by e-mail:
	+ Au, Edward Huawei Technologies Co., Ltd
1. Announcements:
	* Note that tomorrow, 19th of November is the last call for candidates to D0.2.
	* The Chair asks if there are any comments on the agenda. Comments:

C: In previous meeting we discussed NDPA, partial bandwidth indication. I suggest those SPs to be put after the trigger frame RU allocation SPs.

C: The RU table is not decided yet, and we are still having offline discussions. So I propose we defer the SPs on NDPA partial BW indication.

The Chair updates the agenda according to the comments. The Chair adds PDTs for discussion queue. The amended agenda is 1615r14. The Chair asks for approval of the amended agenda. Nobody speaks up. Amended agenda approved.

1. Deferred SPs on Sounding
	* [**1469r0**](https://mentor.ieee.org/802.11/dcn/20/11-20-1469-00-00be-eht-sounding-discussion.pptx) **EHT sounding discussion Liwen Chu [SPs]**

Straw Poll:

* Do you support that in 11be sounding the following rules are defined:

 In NTB sounding, the beamformer shall not poll the sounding feedback

In a TB sounding sequence initiated by NDPA and NDP, an EHT AP shall not poll a beamformee more than one time

Discussion:

C: Thanks for deferring this from the previous meeting. I am happy with this straw poll and support it.

Result: Yes/No/Abstain/No-answer: 67/3/48/41

1. Deferred SPs on Trigger
	* [**1685r2**](https://mentor.ieee.org/802.11/dcn/20/11-20-1685-02-00be-ul-length-indication-in-trigger-frame.pptx) **UL length indication in trigger frame Ross Jian Yu [1 SP]**

Straw poll #1:

* + Do you agree that an EHT AP shall set the UL Length subfield of a trigger frame to the value given by the following equation with m = 2 if the trigger frame is to solicit EHT TB PPDU?

This is for R1



Discussion:

C: How is this related to SP2?

A: If SP1 passes then SP2 must be used as well.

C: Can you merge SP1 and 2?

A: Ok.

 New text:

* + Do you agree to add to the TGbe SFD the following:
	+ An EHT AP shall set the UL Length subfield of a trigger frame to the value given by the following equation with m = 2 if the trigger frame is to solicit EHT TB PPDU?



* + For an EHT STA:
		1. if the EHT STA is solicited to transmit HE TB PPDU, then the LENGTH field in L-SIG field shall be equal to UL length in the trigger frame for an HE TB PPDU;
		2. if the EHT STA is solicited to transmit EHT TB PPDU, then the Length field in L-SIG field shall be equal to UL length in the trigger frame + 2 for an EHT TB PPDU?
	+ This is for R1

Result: Yes/No/Abstain/No-answer: 90/2/45/40

1. **Proposed Draft Text (PDTs) for fixings TBDs**
	* [**1826r1**](https://mentor.ieee.org/802.11/dcn/20/11-20-1826-01-00be-pdt-joint-spatial-stream-and-mimo-protocol.docx) **Joint Spatial Stream and MIMO Protocol Wook Bong Lee**

Summary: Wook Bong goes through updates in the PDT document.

Discussion:

C: For this frame. I think we need a new action frame. Why are we not discussion a new frame?

C: The action frame is in a different subclause.

A: I agree we need a new EHT action frame.

C: In the first paragraph on page 11, what is the EHT Compressed Beamforming/CQI frame?

C: I copied from before.

* + [**1873r0**](https://mentor.ieee.org/802.11/dcn/20/11-20-1873-00-00be-pdt-phy-txtime-and-psdu-length-calculation.docx) **PDT PHY TXTIME and PSDU LENGTH Calculation Youhan Kim**

Summary: Youhan Kim goes through updates to the PDT document.

* + [**1796r3**](https://mentor.ieee.org/802.11/dcn/20/11-20-1796-03-00be-pdt-phy-cyclic-shift.docx) **PDT-PHY-Cyclic-Shift Wook Bong Lee**

Summary: A minor update where a paragraph has been moved.

The Chair asks if there is any objection in the group to approve the editorial update from 1796r2 to 1796r3. Nobody speaks up. Previous SP on 1796r2 is valid for 1796r3.

* + **[1865r2](https://mentor.ieee.org/802.11/dcn/20/11-20-1865-02-00be-pdt-phy-update-to-mu-mimo.docx) PDT PHY Update to MU-MIMO Sameer Vermani**

Summary: Sameer Vermani goes through updates to the PDT.

*The Chair asks if there is any objection to run the SP on this update today. Nobody speaks up. The SP will be run now.*

*The Chair asks if there is any objection to include the changes proposed in* [***1865r2***](https://mentor.ieee.org/802.11/dcn/20/11-20-1865-02-00be-pdt-phy-update-to-mu-mimo.docx)*in the next draft. Nobody speaks up, these changes will be included in the next draft.*

*The Chair asks if there is any objection to add 4 new contributions (1836r0, 1837r0, 1479r3, 1462r3) to todays agenda. Nobody objects. Amended agenda approved.*

* + [**1836r0**](https://mentor.ieee.org/802.11/dcn/20/11-20-1836-00-00be-pdt-phy-tx-procedure.docx) **PDT-PHY-Tx-Procedure Xiaogang Chen**

Summary: Xiaogang Chen goes through the changes in the document.

* + [**1837r0**](https://mentor.ieee.org/802.11/dcn/20/11-20-1837-00-00be-pdt-phy-tx-procedure.docx) **PDT-PHY-Rx-Procedure Xiaogang Chen**

Summary: Xiaogang Chen goes through the changes in the document.

Discussion:

C: Technical discussion on how the rx state machine works for some certain setting.

C: Some discussion on second last paragraph on page 4 regarding BW and PuncturedChannelInformation subfield.

* + [**1479r3**](https://mentor.ieee.org/802.11/dcn/20/11-20-1479-03-00be-pdt-phy-t-block.docx) **PDT-PHY-T\_block Xiaogang Chen**

Summary: Xiaogang Chen goes through the changes in the document.

Discussion:

C: The red wording means TBD?

A: Yes.

* + [**1462r3**](https://mentor.ieee.org/802.11/dcn/20/11-20-1462-03-00be-pdt-phy-tx-mask.docx) **PDT-PHY-Tx-Mask Xiaogang Chen**

Summary: Xiaogang Chen goes through the changes in the document.

**Discussion:**

**C: Why are some spectrum masks not symmetrical?**

**A: Because of the puncturing.**

1. AoB: No other business.
2. Adjourn at 11:56.

# Thursday 19 November 19:00 – 22:00 ET

Split PHY and MAC.

* PHY: <https://mentor.ieee.org/802.11/dcn/20/11-20-1767-06-00be-minutes-for-tgbe-phy-ad-hoc-cc-nov-2020-to-jan-2021.docx>
* MAC: <https://mentor.ieee.org/802.11/dcn/20/11-20-1765-10-00be-minutes-for-tgbe-mac-ad-hoc-teleconferences-in-nov-2020-and-jan-2021.docx>

# Monday 30 December 19:00 – 22:00 ET

Split PHY and MAC.

* PHY: <https://mentor.ieee.org/802.11/dcn/20/11-20-1767-06-00be-minutes-for-tgbe-phy-ad-hoc-cc-nov-2020-to-jan-2021.docx>
* MAC: <https://mentor.ieee.org/802.11/dcn/20/11-20-1765-10-00be-minutes-for-tgbe-mac-ad-hoc-teleconferences-in-nov-2020-and-jan-2021.docx>

# Wednesday 2 December 10:00 – 12:00 ET

**Introduction**

1. The Chair, Alfred Asterjadhi (Qualcomm), calls the meeting to order at 10:02 ET. The Chair notifies that the agenda is in [11-20/1615r20](https://mentor.ieee.org/802.11/dcn/20/11-20-1615-20-00be-nov-jan-tgbe-teleconference-agendas.docx).
2. IEEE 802 and 802.11 IPR policy and procedure. If anyone in this meeting is personally aware of the holder of any patent claims that are potentially essential to implementation of the proposed standard(s) under consideration by this group please speak up now. Nobody speaks/writes up.
3. The Chair goes through **Patent, Participation and policy related subclause,** which is located at the bottom of the agenda document.
4. Attendance reminder.
* Participation slide: <https://mentor.ieee.org/802-ec/dcn/16/ec-16-0180-05-00EC-ieee-802-participation-slide.pptx>
* Please record your attendance during the conference call by using the IMAT system:
	+ 1) login to [imat](https://imat.ieee.org/attendance), 2) select “802.11 Telecons (<Month>)” entry, 3) select “C/LM/WG802.11 Attendance” entry, 4) click “TGbe <MAC/PHY/Joint> conference call that you are attending.
* If you are unable to record the attendance via [IMAT](https://imat.ieee.org/attendance) then please send an e-mail to Dennis Sundman (dennis.sundman@ericsson.com) and Alfred Asterjadhi (aasterja@qti.qualcomm.com)
* Please ensure that the following information is listed correctly when joining the call:
	+ "[voter status] First Name Last Name (Affiliation)"
* Attendence as recorded by IMAT:
* Aboulmagd, Osama Huawei Technologies Co.,  Ltd
* Adhikari, Shubhodeep Broadcom Corporation
* Aio, Kosuke Sony Corporation
* An, Song-Haur INDEPENDENT
* Ansley, Carol IEEE member / Self Employed
* Anwyl, Gary MediaTek Inc.
* Asterjadhi, Alfred Qualcomm Incorporated
* Au, Kwok Shum Huawei Technologies Co.,  Ltd
* Bankov, Dmitry IITP RAS
* baron, stephane Canon Research Centre France
* Bhandaru, Nehru Broadcom Corporation
* Boldy, David Broadcom Corporation
* Bredewoud, Albert Broadcom Corporation
* Cao, Rui NXP Semiconductors
* Carney, William Sony Corporation
* Cepni, Gurkan Apple, Inc.
* CHAN, YEE Facebook
* chen, jindou Huawei Technologies Co. Ltd
* Chen, Na MaxLinear Corp
* Cheng, Paul MediaTek Inc.
* CHERIAN, GEORGE Qualcomm Incorporated
* Chitrakar, Rojan Panasonic Asia Pacific Pte Ltd.
* Choi, Jinsoo LG ELECTRONICS
* Choo, Seungho Senscomm Semiconductor Co., Ltd.
* Chu, Liwen NXP Semiconductors
* CHUN, JINYOUNG LG ELECTRONICS
* Coffey, John Realtek Semiconductor Corp.
* Das, Subir Perspecta Labs Inc.
* Dauphinee, Leonard MaxLinear Inc
* Davies, Robert Signify
* de Vegt, Rolf Qualcomm Incorporated
* Dong, Xiandong Xiaomi Inc.
* Fang, Yonggang Self
* feng, Shuling MediaTek Inc.
* Fischer, Matthew Broadcom Corporation
* Gao, Zhigang Cisco Systems, Inc.
* Garg, Lalit Broadcom Corporation
* Ghaderipoor, Alireza MediaTek Inc.
* Gong, Bo Huawei Technologies Co. Ltd
* Han, Jonghun SAMSUNG
* Han, Zhiqiang ZTE Corporation
* Handte, Thomas Sony Corporation
* Harkins, Daniel Hewlett Packard Enterprise
* Hart, Brian Cisco Systems, Inc.
* Hervieu, Lili Cable Television Laboratories Inc. (CableLabs)
* Hong, Hanseul WILUS Inc.
* Hsieh, Hung-Tao MediaTek Inc.
* Hu, Chunyu Facebook
* Huang, Guogang  Huawei
* Huang, Lei Guangdong OPPO Mobile Telecommunications Corp.,Ltd
* Huang, Po-Kai Intel Corporation
* Inohiza, Hirohiko Canon
* Jamalabdollahi, Mohsen Cisco Systems, Inc.
* Jang, Insun LG ELECTRONICS
* Jiang, Jinjing Apple, Inc.
* Kakani, Naveen Qualcomm Incorporated
* Kamel, Mahmoud InterDigital, Inc.
* Kedem, Oren Huawei Technologies Co. Ltd
* Khorov, Evgeny IITP RAS
* Kim, Jeongki LG ELECTRONICS
* Kim, Myeong-Jin SAMSUNG
* kim, namyeong LG ELECTRONICS
* Kim, Sang Gook LG ELECTRONICS
* Kim, Sanghyun WILUS Inc
* Kim, Youhan Qualcomm Incorporated
* Kishida, Akira Nippon Telegraph and Telephone Corporation (NTT)
* Klein, Arik Huawei Technologies Co. Ltd
* Klimakov, Andrey Huawei Technologies Co., Ltd
* Ko, Geonjung WILUS Inc.
* Kondo, Yoshihisa Advanced Telecommunications Research Institute International (ATR)
* Kwon, Young Hoon NXP Semiconductors
* Lalam, Massinissa SAGEMCOM BROADBAND SAS
* Lansford, James Qualcomm Incorporated
* Lee, Wookbong SAMSUNG
* Levy, Joseph InterDigital, Inc.
* Li, Jialing Qualcomm Incorporated
* Li, Yiqing Huawei Technologies Co. Ltd
* Li, Yunbo Huawei Technologies Co., Ltd
* Lim, Dong Guk LG ELECTRONICS
* Liu, Jianfei HUAWEI
* Liu, Jianhan MediaTek Inc.
* Lorgeoux, Mikael Canon Research Centre France
* Lou, Hanqing InterDigital, Inc.
* Lu, kaiying MediaTek Inc.
* Lu, Liuming ZTE Corporation
* Luo, Chaoming Beijing OPPO telecommunications corp., ltd.
* Ma, Mengyao HUAWEI
* Martinez Vazquez, Marcos MaxLinear Corp
* Max, Sebastian Ericsson AB
* McCann, Stephen Huawei Technologies Co.,  Ltd
* Memisoglu, Ebubekir Istanbul Medipol University; Vestel
* Montemurro, Michael Huawei Technologies Co. Ltd
* Montreuil, Leo Broadcom Corporation
* NANDAGOPALAN, SAI SHANKAR Cypress Semiconductor Corporation
* Nezou, Patrice Canon Research Centre France
* Ng, Boon Loong Samsung Research America
* noh, yujin Newracom Inc.
* Ozbakis, Basak VESTEL
* OZDEN ZENGIN, OZLEM VESTEL
* Palayur, Saju Maxlinear Inc
* Palm, Stephen Broadcom Corporation
* Park, Eunsung LG ELECTRONICS
* Park, Minyoung Intel Corporation
* Patil, Abhishek Qualcomm Incorporated
* Patwardhan, Gaurav Hewlett Packard Enterprise
* Petrick, Albert InterDigital, Inc.
* Petry, Brian Broadcom Corporation
* porat, ron Broadcom Corporation
* Pushkarna, Rajat Panasonic Asia Pacific Pte Ltd.
* Redlich, Oded HUAWEI
* Rosdahl, Jon Qualcomm Technologies, Inc.
* Salman, Hanadi Istanbul Medipol University; VESTEL
* Schelstraete, Sigurd Quantenna Communications, Inc.
* Sethi, Ankit NXP Semiconductors
* Shellhammer, Stephen Qualcomm Incorporated
* Shilo, Shimi HUAWEI
* SUH, JUNG HOON Huawei Technologies Co. Ltd
* Sun, Bo ZTE Corporation
* Sun, Li-Hsiang Sony Corporation
* Sundman, Dennis Ericsson AB
* THOUMY, Francois Canon Research Centre France
* Tian, Bin Qualcomm Incorporated
* Tsodik, Genadiy Huawei Technologies Co. Ltd
* Urabe, Yoshio Panasonic Corporation
* Van Zelst, Allert Qualcomm Incorporated
* Varshney, Prabodh Nokia
* Verenzuela, Daniel Sony Corporation
* Verma, Sindhu Broadcom Corporation
* Wang, Chao Chun MediaTek Inc.
* Wang, Hao Tencent
* Wang, Huizhao Quantenna Communications, Inc.
* Wang, Qi Apple, Inc.
* Wilhelmsson, Leif Ericsson AB
* Xin, Yan Huawei Technologies Co., Ltd
* Yang, Jay Nokia
* Yang, Steve TS MediaTek Inc.
* Yano, Kazuto Advanced Telecommunications Research Institute International (ATR)
* yi, yongjiang Futurewei Technologies
* Young, Christopher Broadcom Corporation
* Yu, Jian Huawei Technologies Co., Ltd
* Zeng, Yan Huawei Technologies Co.,  Ltd
* Zhang, Yan NXP Semiconductors
* Zhou, Yifan Huawei Technologies Co., Ltd
* Zuo, Xin Tencent
1. Announcements:
	* D0.2 expected to be posted to member area of IEEE website by today EOD.
		+ C: For our members, please use the .rtf files when preparing the PDTs.

*The Chair goes through the agenda.*

* *The technical submission 1826r3 is deferred from this meeting. It can probably be presented next joint call.*
* *The SP 1015r5 is deferred to next joint call.*
* *The latest version of 997 is r71.*
* *The SP 1747 and 1814 will also be deferred since the 1015 SP was deferred.*
* *The Chair adds two (1808 and 1911) technical contributions on trigger to the agenda.*
* *The Chair asks if there is any objection to approve the agenda with above modifications? Nobody speaks up. Agenda approved.*
1. Motions: [841r40](https://mentor.ieee.org/802.11/dcn/20/11-20-0841-40-00be-tgbe-motions-list-for-teleconferences.pptx) Motions list for teleconferences
	1. **(Re-) Approve TG minutes**

**Move to approve TGbe minutes of teleconferences listed below:**

* + Teleconferences Sept-Nov: <https://mentor.ieee.org/802.11/dcn/20/11-20-1496-08-00be-sep-nov-tgbe-teleconference-minutes.docx>
	+ Teleconferences July-Sept: <https://mentor.ieee.org/802.11/dcn/20/11-20-1109-07-00be-july-september-tgbe-teleconference-minutes.docx>

**Move: Dennis Sundman Second: Stephen McCann**

**Discussion: No discussion.**

**Result: Approved with unanimous consent.**

Note: Updated minutes (one revision ahead) to be motioned fix some minor inconsistencies in the earlier minutes.

* 1. Motion 144

**Move to add to the 11be SFD, candidate specification text in** [**11-20/566r98**](https://mentor.ieee.org/802.11/dcn/20/11-20-0566-98-00be-compendium-of-straw-polls-and-potential-changes-to-the-specification-framework-document.docx) **that is identified with the following tags:**

* + SP311, SP312, SP313, SP314, SP315, SP316, SP317, SP318, SP319, SP320,
	+ SP321, SP322, SP323, SP324, SP325, SP326, SP327, SP328, SP329, SP330,
	+ SP331, SP332, SP333

**And additionally instruct the TGbe Editor to replace the tables 36-5, 36-6, and 36.7 of the TGbe draft with the tables provided by SP332.**

**Move: Edward Au Second: Wook Bong Lee**

**Discussion:**

**C: It should be revision 98.**

**Result: Approved with unanimous consent.**

**Note: These are all candidate SFD texts highlighted in yellow that have NOT received a request for further discussion**

* 1. Motion 145

**Move to accept changes to the TGbe draft as specified in the following documents:**

* + [1594r4](https://mentor.ieee.org/802.11/dcn/20/11-20-1594-04-00be-mlo-critical-updates-indication-address-missing-details.docx), [1651r6](https://mentor.ieee.org/802.11/dcn/20/11-20-1651-06-00be-pdt-tbds-mac-mlo-discovery-discovery-procedures-including-probing-and-rnr.docx), [1835r3](https://mentor.ieee.org/802.11/dcn/20/11-20-1835-03-00be-pdt-mac-mlo-ml-element-common-format-and-types.docx), [1881r0](https://mentor.ieee.org/802.11/dcn/20/11-20-1881-00-00be-resolve-tbds-in-35-3-8.docx),
	+ [1479r4](https://mentor.ieee.org/802.11/dcn/20/11-20-1479-04-00be-pdt-phy-t-block.docx), [1462r4](https://mentor.ieee.org/802.11/dcn/20/11-20-1462-04-00be-pdt-phy-tx-mask.docx), [1495r6](https://mentor.ieee.org/802.11/dcn/20/11-20-1495-06-00be-pdt-of-eht-ltf-sequences.docx), [1766r1](https://mentor.ieee.org/802.11/dcn/20/11-20-1766-01-00be-pdt-cca-sensitivity.docx), [1783r3](https://mentor.ieee.org/802.11/dcn/20/11-20-1783-03-00be-update-on-pdt-phy-introduction-to-eht-phy.docx), [1791r5](https://mentor.ieee.org/802.11/dcn/20/11-20-1791-05-00be-pdt-tbd-phy-modulation-accuracy.docx), [1792r0](https://mentor.ieee.org/802.11/dcn/20/11-20-1792-00-00be-pdt-tbd-phy-frequency-tolerance.docx), [1793r0](https://mentor.ieee.org/802.11/dcn/20/11-20-1793-00-00be-pdt-tbd-phy-receive-specification-general-and-receiver-minimum-input-sensitivity-and-channel-rejection.docx), [1796r2](https://mentor.ieee.org/802.11/dcn/20/11-20-1796-02-00be-pdt-phy-cyclic-shift.docx), [1803r3](https://mentor.ieee.org/802.11/dcn/20/11-20-1803-03-00be-pdt-phy-ru-mru-restrictions-for-20-mhz-operation.docx),
	+ [1836r0](https://mentor.ieee.org/802.11/dcn/20/11-20-1836-00-00be-pdt-phy-tx-procedure.docx), [1837r2](https://mentor.ieee.org/802.11/dcn/20/11-20-1837-02-00be-pdt-phy-rx-procedure.docx), [1865r2](https://mentor.ieee.org/802.11/dcn/20/11-20-1865-02-00be-pdt-phy-update-to-mu-mimo.docx), [1867r1](https://mentor.ieee.org/802.11/dcn/20/11-20-1867-01-00be-pdt-phy-non-ht-duplicate-transmission.docx), [1868r3](https://mentor.ieee.org/802.11/dcn/20/11-20-1868-03-00be-pdt-phy-ofdm-modulation.docx), [1873r0](https://mentor.ieee.org/802.11/dcn/20/11-20-1873-00-00be-pdt-phy-txtime-and-psdu-length-calculation.docx), [1875r2](https://mentor.ieee.org/802.11/dcn/20/11-20-1875-01-00be-pdt-phy-update-to-preamble-u-sig.docx), [1876r5](https://mentor.ieee.org/802.11/dcn/20/11-20-1876-05-00be-update-on-pdt-phy-pilot.docx), [1878r1](https://mentor.ieee.org/802.11/dcn/20/11-20-1878-01-00be-pdt-phy-update-to-eht-sounding-ndp.docx), [1882r3](https://mentor.ieee.org/802.11/dcn/20/11-20-1882-03-00be-pdt-phy-overview-of-the-ppdu-enconding-process.docx),
	+ [1883r1](https://mentor.ieee.org/802.11/dcn/20/11-20-1883-01-00be-pdt-eht-ppdu-format-update.docx), [1884r0](https://mentor.ieee.org/802.11/dcn/20/11-20-1884-00-00be-pdt-phy-stream-parser.docx), [1885r0](https://mentor.ieee.org/802.11/dcn/20/11-20-1885-00-00be-pdt-eht-preamble-l-stf-l-ltf-and-l-sig-update.docx), [1888r3](https://mentor.ieee.org/802.11/dcn/20/11-20-1888-03-00be-pdt-phy-removing-non-contiguous-ppdu.docx),

**And instruct the TGbe Editor to create IEEE802.11be D0.2 draft after incorporating these additional changes along with other approved changes as specified in Motions 136, 138, 140, 143, and 144.**

**Move: Laurent Cariou Second: Ross Jian Yu**

**Discussion: No discussion.**

**Result: Approved with unanimous consent.**

**Note 1: These are all proposed draft texts (PDTs) that obtained ≥ 75% support during the straw poll phase and that have NOT received a request for further discussion**

**Note 2: 1868r3 and 1876r5 were revised to fix some technical typos and were re-discussed in PHY ad-hoc conf call on Monday 11/30/2020. SPs on the changes had unanimous consent.**

1. Status of the spec text (Edward Au)
	1. Edward goes through the number of TBDs per Clause for the different drafts.
	2. Some text in the spec text volunteers and status document (997r71 🡪 997r72) is highlighted green.
2. Technical submissions – Trigger Frames
	1. [**1808r1**](https://mentor.ieee.org/802.11/dcn/20/11-20-1808-01-00be-backward-compatible-eht-trigger-frame-follow-up.pptx)**, “Backward compatible EHT trigger frame follow up” – Ming Gan (Huawei)**

Summary: Because of the increased number of spatial streams and extended bandwitdth, the trigger frame needs to be extended. The authors present two (backwards compatible) options.

Discussion:
C: For option 1 do you want to send different content for different 80 MHz?

A: No.

C: So the whole 320 MHz will either be for HE or EHT (again option 1)?

A: No. This is indicated in each 20 MHz.

C: So this means that EHT always transmits HE TB PPDU?

A: Yes.

 *There are some unclarities regarding tables on slide 10.*

* 1. [**1911r0,**](https://mentor.ieee.org/802.11/dcn/20/11-20-1911-00-00be-ul-bw-subfield-design-in-trigger-frame.pptx) **“UL BW subfield design in Trigger frame” – Jinyoung Chun (LGE)**

Summary: The authors believe the trigger frame should be able to trigger HE and EHT STA simultaneously. Therefore, the trigger frame needs to be backwards compatible.

Discussion:

*Some discussion regarding principles of signalling, most notably issues with backwards compatibility and complications that may arise in R2.*

1. AoB: None.
2. Adjourned at 11:54.

# Thursday 3 December 10:00 – 12:00 ET

Split PHY and MAC.

* PHY: <https://mentor.ieee.org/802.11/dcn/20/11-20-1767-06-00be-minutes-for-tgbe-phy-ad-hoc-cc-nov-2020-to-jan-2021.docx>
* MAC: <https://mentor.ieee.org/802.11/dcn/20/11-20-1765-10-00be-minutes-for-tgbe-mac-ad-hoc-teleconferences-in-nov-2020-and-jan-2021.docx>

# Monday 7 December 10:00 – 12:00 ET

Split PHY and MAC.

* PHY: <https://mentor.ieee.org/802.11/dcn/20/11-20-1767-06-00be-minutes-for-tgbe-phy-ad-hoc-cc-nov-2020-to-jan-2021.docx>
* MAC: <https://mentor.ieee.org/802.11/dcn/20/11-20-1765-10-00be-minutes-for-tgbe-mac-ad-hoc-teleconferences-in-nov-2020-and-jan-2021.docx>

# Wednesday 9 December 10:00 – 12:00 ET

**Introduction**

1. The Chair, Alfred Asterjadhi (Qualcomm), calls the meeting to order at 10:02 ET. The Chair notifies that the agenda is in [11-20/1615r25](https://mentor.ieee.org/802.11/dcn/20/11-20-1615-25-00be-nov-jan-tgbe-teleconference-agendas.docx).
2. IEEE 802 and 802.11 IPR policy and procedure.
3. The Chair goes through **Patent, Participation and policy related subclause,** which is located at the bottom of the agenda document.
4. Attendance reminder.
* Participation slide: <https://mentor.ieee.org/802-ec/dcn/16/ec-16-0180-05-00EC-ieee-802-participation-slide.pptx>
* Please record your attendance during the conference call by using the IMAT system:
	+ 1) login to [imat](https://imat.ieee.org/attendance), 2) select “802.11 Telecons (<Month>)” entry, 3) select “C/LM/WG802.11 Attendance” entry, 4) click “TGbe <MAC/PHY/Joint> conference call that you are attending.
* If you are unable to record the attendance via [IMAT](https://imat.ieee.org/attendance) then please send an e-mail to Dennis Sundman (dennis.sundman@ericsson.com) and Alfred Asterjadhi (aasterja@qti.qualcomm.com)
* Please ensure that the following information is listed correctly when joining the call:
	+ "[voter status] First Name Last Name (Affiliation)"
* Attendence as recorded by IMAT:
* An, Song-Haur INDEPENDENT
* Anwyl, Gary MediaTek Inc.
* Au, Kwok Shum Huawei Technologies Co.,  Ltd
* B, Hari Ram NXP Semiconductors
* Baek, SunHee LG ELECTRONICS
* Bankov, Dmitry IITP RAS
* baron, stephane Canon Research Centre France
* Bredewoud, Albert Broadcom Corporation
* Carney, William Sony Corporation
* Cheng, Paul MediaTek Inc.
* Chitrakar, Rojan Panasonic Asia Pacific Pte Ltd.
* Choi, Jinsoo LG ELECTRONICS
* CHUN, JINYOUNG LG ELECTRONICS
* Chung, Chulho SAMSUNG
* Das, Subir Perspecta Labs Inc.
* Dong, Xiandong Xiaomi Inc.
* Du, Zhenguo Huawei Technologies Co.,  Ltd
* Erceg, Vinko Broadcom Corporation
* Fang, Yonggang Self
* Fischer, Matthew Broadcom Corporation
* Gong, Bo Huawei Technologies Co. Ltd
* Guo, Yuchen Huawei Technologies Co., Ltd
* Haasz, Jodi IEEE Standards Association (IEEE-SA)
* Haider, Muhammad Kumail Facebook
* Han, Jonghun SAMSUNG
* Han, Zhiqiang ZTE Corporation
* Handte, Thomas Sony Corporation
* Hart, Brian Cisco Systems, Inc.
* Ho, Duncan Qualcomm Incorporated
* Hong, Hanseul WILUS Inc.
* Hsieh, Hung-Tao MediaTek Inc.
* Hu, Chunyu Facebook
* Huang, Guogang  Huawei
* Huang, Lei Guangdong OPPO Mobile Telecommunications Corp.,Ltd
* Huang, Po-Kai Intel Corporation
* Jamalabdollahi, Mohsen Cisco Systems, Inc.
* Jang, Insun LG ELECTRONICS
* Jeon, Eunsung SAMSUNG ELECTRONICS
* Ji, Chenhe Huawei Technologies Co. Ltd
* Kain, Carl USDoT
* Kakani, Naveen Qualcomm Incorporated
* Kamel, Mahmoud InterDigital, Inc.
* Kandala, Srinivas SAMSUNG
* Kedem, Oren Huawei Technologies Co. Ltd
* Kim, Jeongki LG ELECTRONICS
* Kim, Myeong-Jin SAMSUNG
* kim, namyeong LG ELECTRONICS
* Kim, Sang Gook LG ELECTRONICS
* Kim, Sanghyun WILUS Inc
* Kim, Youhan Qualcomm Incorporated
* Kishida, Akira Nippon Telegraph and Telephone Corporation (NTT)
* Klein, Arik Huawei Technologies Co. Ltd
* Klimakov, Andrey Huawei Technologies Co., Ltd
* Ko, Geonjung WILUS Inc.
* Kondo, Yoshihisa Advanced Telecommunications Research Institute International (ATR)
* Kwon, Young Hoon NXP Semiconductors
* Lansford, James Qualcomm Incorporated
* Lee, Nancy Signify
* Lee, Wookbong SAMSUNG
* Le Houerou, Brice Canon Research Centre France
* Levitsky, Ilya IITP RAS
* Li, Jianhui Huawei Technologies Co.,  Ltd
* Li, Yiqing Huawei Technologies Co. Ltd
* Lim, Dong Guk LG ELECTRONICS
* LIU, CHENCHEN Huawei Technologies Co., Ltd
* Liu, Der-Zheng Realtek Semiconductor Corp.
* Liu, Jianfei HUAWEI
* Liu, Jianhan MediaTek Inc.
* Lopez, Miguel Ericsson AB
* Lou, Hanqing InterDigital, Inc.
* Lu, kaiying MediaTek Inc.
* Lu, Liuming ZTE Corporation
* Ma, Li MediaTek Inc.
* Ma, Mengyao HUAWEI
* Martinez Vazquez, Marcos MaxLinear Corp
* Max, Sebastian Ericsson AB
* McCann, Stephen Huawei Technologies Co.,  Ltd
* Monajemi, Pooya Cisco Systems, Inc.
* Montemurro, Michael Huawei Technologies Co. Ltd
* Nezou, Patrice Canon Research Centre France
* Ng, Boon Loong Samsung Research America
* noh, yujin Newracom Inc.
* Ouchi, Masatomo Canon
* Ozbakis, Basak VESTEL
* OZDEN ZENGIN, OZLEM VESTEL
* Palayur, Saju Maxlinear Inc
* Pare, Thomas MediaTek Inc.
* Park, Eunsung LG ELECTRONICS
* Park, Minyoung Intel Corporation
* Patwardhan, Gaurav Hewlett Packard Enterprise
* Petrick, Albert InterDigital, Inc.
* Redlich, Oded HUAWEI
* Rosdahl, Jon Qualcomm Technologies, Inc.
* Salman, Hanadi Istanbul Medipol University; VESTEL
* Schelstraete, Sigurd Quantenna Communications, Inc.
* Sethi, Ankit NXP Semiconductors
* Shellhammer, Stephen Qualcomm Incorporated
* Shilo, Shimi HUAWEI
* Solaija, Muhammad Sohaib Istanbul Medipol University; Vestel
* SUH, JUNG HOON Huawei Technologies Co. Ltd
* Sun, Bo ZTE Corporation
* Sun, Li-Hsiang Sony Corporation
* Sundaram, Rajesh Broadcom Corporation
* Tanaka, Yusuke Sony Corporation
* THOUMY, Francois Canon Research Centre France
* Tian, Bin Qualcomm Incorporated
* Torab Jahromi, Payam Facebook
* Tsodik, Genadiy Huawei Technologies Co. Ltd
* Varshney, Prabodh Nokia
* Verenzuela, Daniel Sony Corporation
* Vermani, Sameer Qualcomm Incorporated
* VIGER, Pascal Canon Research Centre France
* Wang, Chao Chun MediaTek Inc.
* Wang, Huizhao Quantenna Communications, Inc.
* Wilhelmsson, Leif Ericsson AB
* Wu, Tianyu Apple, Inc.
* Wullert, John Perspecta Labs
* Xin, Yan Huawei Technologies Co., Ltd
* Yang, Jay Nokia
* Yang, Steve TS MediaTek Inc.
* Yano, Kazuto Advanced Telecommunications Research Institute International (ATR)
* Yee, James MediaTek Inc.
* yi, yongjiang Futurewei Technologies
* Yu, Jian Huawei Technologies Co., Ltd
* Zein, Nader NEC Laboratories Europe
* Zhang, Yan NXP Semiconductors
* Zhou, Yifan Huawei Technologies Co., Ltd
* Individually reported:
* Alfred Asterjadhi Qualcomm
* Abhishek Patil Qualcomm
* Dennis Sundman Ericsson
1. Announcements: D0.2 is posted in the members area.

*The Chair goes through the agenda.*

* *Some discussion regarding which SPs to be run. The agenda is getting updated accordingly.*

*The Chair gets reminded that he forgot to ask for potentially essential patents:*

*If anyone in this meeting is personally aware of the holder of any patent claims that are potentially essential to implementation of the proposed standard(s) under consideration by this group please speak up now.* ***Nobody speaks/writes up.***

*The Chair continues discussing the agenda.*

* *Some reordering of the SP and presentations. Most notable 1927 to be presented before SPs being run.*
* *Agenda approved with unanimous consent.*
1. Technical Submissions: **Proposed Draft Text (PDTs) for fixings TBDs**
	1. [**1826r5**](https://mentor.ieee.org/802.11/dcn/20/11-20-1826-05-00be-pdt-joint-spatial-stream-and-mimo-protocol.docx)**, “Joint Spatial Stream and MIMO Protocol” – Wook Bong Lee [SP]**

Summary: Wook Bong Lee goes through the document.

SP: Do you support to incorporate the changes in 11-20/1826r6 in the next version of TGbe draft?

Result: Yes/No/Abstain/No-answer: 87/0/29/65

1. Technical Submissions – Trigger frame format:

* + [**1429r3**](https://mentor.ieee.org/802.11/dcn/20/11-20-1429-03-00be-enhanced-trigger-frame-for-eht-support.pptx) **Enhanced Trigger Frame for EHT Support Steve Shellhammer**

Summary: Steve explains the updates to previous revisions.

Discussion:

C: Slide 22, Is this a two step process to determine HE or EHT?

A: Yes. First you determine which RU before determining HE or EHT.

C: Slide 21, maybe the 80 MHz value could also be 160 MHz?

A: Good point. My view on that is that we defer those decisions to R2.

* + [**1927r0**](https://mentor.ieee.org/802.11/dcn/20/11-20-1927-00-00be-clean-ul-bw-signaling-in-enhanced-trigger-frame.pptx) **Clean UL BW signaling in Enhanced Trigger frame Lei Huang**

Summary: The authors explain a proposed method for signalling UL BW.

Discussion:

C: The UL BW and delta UL BW requires 4 bits. Why not use simply 3 bits that is sufficient?

A: Only the Delta UL BW is new.

C: I am not convinced we should do this relatively complex design when the 1 bit modification presented earlier should be sufficient.

A: Good point, let’s discuss offline.

1. AoB:
	* Should we keep the PHY call tomorrow although it’s only 1 contribution?
2. Adjourn at 12:01.

# Thursday 10 December 19:00 – 22:00 ET

Split PHY and MAC.

* PHY: <https://mentor.ieee.org/802.11/dcn/20/11-20-1767-06-00be-minutes-for-tgbe-phy-ad-hoc-cc-nov-2020-to-jan-2021.docx>
* MAC: <https://mentor.ieee.org/802.11/dcn/20/11-20-1765-10-00be-minutes-for-tgbe-mac-ad-hoc-teleconferences-in-nov-2020-and-jan-2021.docx>

# Monday 14 December 19:00 – 22:00 ET

Split PHY and MAC.

* PHY: <https://mentor.ieee.org/802.11/dcn/20/11-20-1767-06-00be-minutes-for-tgbe-phy-ad-hoc-cc-nov-2020-to-jan-2021.docx>
* MAC: <https://mentor.ieee.org/802.11/dcn/20/11-20-1765-10-00be-minutes-for-tgbe-mac-ad-hoc-teleconferences-in-nov-2020-and-jan-2021.docx>

# Wednesday 16 December 10:00 – 12:00 ET

**Introduction**

1. The Chair, Alfred Asterjadhi (Qualcomm), calls the meeting to order at 10:02 ET. The Chair notifies that the agenda is in [11-20/1615r33](https://mentor.ieee.org/802.11/dcn/20/11-20-1615-33-00be-nov-jan-tgbe-teleconference-agendas.docx).
2. IEEE 802 and 802.11 IPR policy and procedure. If anyone in this meeting is personally aware of the holder of any patent claims that are potentially essential to implementation of the proposed standard(s) under consideration by this group please speak up now. **Nobody speaks/writes up.**
3. The Chair goes through **Patent and Procedures,** which is located at the bottom of the agenda document.
4. Attendance reminder.
* Participation slide: <https://mentor.ieee.org/802-ec/dcn/16/ec-16-0180-05-00EC-ieee-802-participation-slide.pptx>
* Please record your attendance during the conference call by using the IMAT system:
	+ 1) login to [imat](https://imat.ieee.org/attendance), 2) select “802.11 Telecons (<Month>)” entry, 3) select “C/LM/WG802.11 Attendance” entry, 4) click “TGbe <MAC/PHY/Joint> conference call that you are attending.
* If you are unable to record the attendance via [IMAT](https://imat.ieee.org/attendance) then please send an e-mail to Dennis Sundman (dennis.sundman@ericsson.com) and Alfred Asterjadhi (aasterja@qti.qualcomm.com)
* Please ensure that the following information is listed correctly when joining the call:
	+ "[voter status] First Name Last Name (Affiliation)"
* Attendence as recorded by IMAT:
* AbidRabbu, Shaima' Istanbul Medipol University; Vestel
* Aboulmagd, Osama Huawei Technologies Co.,  Ltd
* Adhikari, Shubhodeep Broadcom Corporation
* An, Song-Haur INDEPENDENT
* Anwyl, Gary MediaTek Inc.
* Au, Kwok Shum Huawei Technologies Co.,  Ltd
* Avital, Ziv MaxLinear
* B, Hari Ram NXP Semiconductors
* Baek, SunHee LG ELECTRONICS
* Bankov, Dmitry IITP RAS
* baron, stephane Canon Research Centre France
* Bhandaru, Nehru Broadcom Corporation
* Boldy, David Broadcom Corporation
* Bravo, Daniel Intel Corporation
* Bredewoud, Albert Broadcom Corporation
* Carney, William Sony Corporation
* Chen, Na MaxLinear Corp
* Cheng, Paul MediaTek Inc.
* CHERIAN, GEORGE Qualcomm Incorporated
* Chitrakar, Rojan Panasonic Asia Pacific Pte Ltd.
* Choi, Jinsoo LG ELECTRONICS
* Chu, Liwen NXP Semiconductors
* CHUN, JINYOUNG LG ELECTRONICS
* Chung, Chulho SAMSUNG
* Coffey, John Realtek Semiconductor Corp.
* Das, Subir Perspecta Labs Inc.
* Derham, Thomas Broadcom Corporation
* de Vegt, Rolf Qualcomm Incorporated
* Dong, Xiandong Xiaomi Inc.
* Duan, Ruchen SAMSUNG
* Erceg, Vinko Broadcom Corporation
* Fang, Yonggang Self
* feng, Shuling MediaTek Inc.
* Fischer, Matthew Broadcom Corporation
* Ghaderipoor, Alireza MediaTek Inc.
* Gong, Bo Huawei Technologies Co. Ltd
* Gu, Xiangxin Unisoc
* Haasz, Jodi IEEE Standards Association (IEEE-SA)
* Han, Jonghun SAMSUNG
* Han, Zhiqiang ZTE Corporation
* Handte, Thomas Sony Corporation
* Hart, Brian Cisco Systems, Inc.
* Hervieu, Lili Cable Television Laboratories Inc. (CableLabs)
* Ho, Duncan Qualcomm Incorporated
* Hong, Hanseul WILUS Inc.
* Hsieh, Hung-Tao MediaTek Inc.
* Hu, Chunyu Facebook
* Huang, Lei Guangdong OPPO Mobile Telecommunications Corp.,Ltd
* Jamalabdollahi, Mohsen Cisco Systems, Inc.
* Jeon, Eunsung SAMSUNG ELECTRONICS
* Kain, Carl USDoT
* Kakani, Naveen Qualcomm Incorporated
* Kamel, Mahmoud InterDigital, Inc.
* Kandala, Srinivas SAMSUNG
* Kedem, Oren Huawei Technologies Co. Ltd
* Kim, Jeongki LG ELECTRONICS
* Kim, Myeong-Jin SAMSUNG
* kim, namyeong LG ELECTRONICS
* Kim, Sang Gook LG ELECTRONICS
* Kim, Sanghyun WILUS Inc
* Kim, Youhan Qualcomm Incorporated
* Kishida, Akira Nippon Telegraph and Telephone Corporation (NTT)
* Klein, Arik Huawei Technologies Co. Ltd
* Klimakov, Andrey Huawei Technologies Co., Ltd
* Kondo, Yoshihisa Advanced Telecommunications Research Institute International (ATR)
* Kwon, Young Hoon NXP Semiconductors
* Lalam, Massinissa SAGEMCOM BROADBAND SAS
* Lansford, James Qualcomm Incorporated
* Lee, Nancy Signify
* Lee, Wookbong SAMSUNG
* Le Houerou, Brice Canon Research Centre France
* Li, Yiqing Huawei Technologies Co. Ltd
* Li, Yunbo Huawei Technologies Co., Ltd
* Lim, Dong Guk LG ELECTRONICS
* Lorgeoux, Mikael Canon Research Centre France
* Lou, Hanqing InterDigital, Inc.
* Lu, kaiying MediaTek Inc.
* Lu, Liuming ZTE Corporation
* Luo, Chaoming Beijing OPPO telecommunications corp., ltd.
* Ma, Li MediaTek Inc.
* Max, Sebastian Ericsson AB
* McCann, Stephen Huawei Technologies Co.,  Ltd
* Memisoglu, Ebubekir Istanbul Medipol University; Vestel
* Monajemi, Pooya Cisco Systems, Inc.
* Montemurro, Michael Huawei Technologies Co. Ltd
* Montreuil, Leo Broadcom Corporation
* NANDAGOPALAN, SAI SHANKAR Cypress Semiconductor Corporation
* Nezou, Patrice Canon Research Centre France
* Ng, Boon Loong Samsung Research America
* noh, yujin Newracom Inc.
* Ouchi, Masatomo Canon
* Ozbakis, Basak VESTEL
* Palm, Stephen Broadcom Corporation
* Pare, Thomas MediaTek Inc.
* Park, Eunsung LG ELECTRONICS
* Park, Minyoung Intel Corporation
* Patil, Abhishek Qualcomm Incorporated
* Patwardhan, Gaurav Hewlett Packard Enterprise
* Petrick, Albert InterDigital, Inc.
* porat, ron Broadcom Corporation
* Puducheri, Srinath Broadcom Corporation
* Pushkarna, Rajat Panasonic Asia Pacific Pte Ltd.
* Raissinia, Alireza Qualcomm Incorporated
* Redlich, Oded HUAWEI
* RISON, Mark Samsung Cambridge Solution Centre
* Rosdahl, Jon Qualcomm Technologies, Inc.
* Schelstraete, Sigurd Quantenna Communications, Inc.
* Sedin, Jonas Ericsson AB
* Sevin, Julien Canon Research Centre France
* Shellhammer, Stephen Qualcomm Incorporated
* Shilo, Shimi HUAWEI
* Solaija, Muhammad Sohaib Istanbul Medipol University; Vestel
* Stacey, Robert Intel Corporation
* Stanley, Dorothy Hewlett Packard Enterprise
* SUH, JUNG HOON Huawei Technologies Co. Ltd
* Sun, Bo ZTE Corporation
* Sun, Li-Hsiang Sony Corporation
* Sundman, Dennis Ericsson AB
* Tanaka, Yusuke Sony Corporation
* Torab Jahromi, Payam Facebook
* Tsodik, Genadiy Huawei Technologies Co. Ltd
* Turkmen, Halise Istanbul Medipol University; Vestel
* Urabe, Yoshio Panasonic Corporation
* Van Zelst, Allert Qualcomm Incorporated
* Varshney, Prabodh Nokia
* Verenzuela, Daniel Sony Corporation
* Verma, Sindhu Broadcom Corporation
* Vermani, Sameer Qualcomm Incorporated
* VIGER, Pascal Canon Research Centre France
* Wang, Chao Chun MediaTek Inc.
* Wang, Hao Tencent
* Wang, Huizhao Quantenna Communications, Inc.
* Wang, Lei Futurewei Technologies
* Wang, Qi Apple, Inc.
* Wu, Tianyu Apple, Inc.
* Wullert, John Perspecta Labs
* Xin, Yan Huawei Technologies Co., Ltd
* Yano, Kazuto Advanced Telecommunications Research Institute International (ATR)
* Yee, James MediaTek Inc.
* yi, yongjiang Futurewei Technologies
* Young, Christopher Broadcom Corporation
* Yu, Jian Huawei Technologies Co., Ltd
* Zhang, Yan NXP Semiconductors
* Zhou, Yifan Huawei Technologies Co., Ltd
* Zuo, Xin Tencent
1. Announcements:
	* PHY call on Thursday 17th December is cancelled.

*The Chair updates the agenda and asks if there is any objection to approve the agenda after being updated. Agenda approved.*

1. [**1961r0**](https://mentor.ieee.org/802.11/dcn/20/11-20-1961-00-00be-release-guidelines-an-overview.pptx)**, “Release Guidelines-An Overview” – Alfred Asterjadhi (Qualcomm)**

Summary: The authors present a detailed timeline, particularly focusing on when R1 and R2 features shall be incorporated in the spec.

Discussion:

C: Am I correctly understanding that technologies to reach R1 must be approved by end of January 2021?

A: Correct.

*Some discussion regarding details of dates in the presentation.*

C: I think this document needs to be discussed on WG level.

A: I will discuss this on WG level.

C: In slide 8, what are the consequences if drafts pass/fails? I believe this needs to be incorporated in this flowchart.

C: How official is this R1/R2 split? Is it internal in the TGbe, or is it on WG level, or EC level, or is it even outside 802.11?

A: My interpretation is that this is on TG level.

C: Slide 6, what will the TG do when an R2 feature appears that needs to change something in R1? Essentially how will you address if people want to incorporate R2 features in R1?

A: I think it should be ruled as out of scope.

C: Would it be possible to reduce the time of announcements of motions until it is run?

A: I will look into it.

C: This R1/R2 is not really compatible with 802.11. Therefore, I request that we have a careful discussion with WG leadership.

A: We have also earlier incorporated new features during the draft process. But I will have a discussion with WG leadership.

C: The TG Chair main responsibility is to lead the group and ensure that we follow a timeline, allow people to speak up, etc. In my opinion R1/R2 is a TG categorization. But when you get to the WG ballot, the standard should be complete (i.e., both R1 and R2 features).

1. Teleconference plan: The Chair goes through the teleconference plan for next year. No comments from the group.
2. Technical Submission:
	* **11-20/1713r2, “Multi-AP Coordination: Recap and Additional Considerations” – Muhammad Sohaib J. Solaija.**

Summary: The authors present a review of the discussions that already taken place in the group and identify some points that should be targeted. In particular they consider: group formation, coordination scheme selection, advertisement.

Discussion:

C: For slide 10, you assume all APs are capable of all sorts of schemes.

A: Yes.

C: It would be good if you can align the terminology from previous discussions in the group.

1. AoB: None.
2. Adjourned at 9:52.